



COZ Series Ceramic SMD Oscillator



- Ceramic SMD package
- 1.8V to 5.0V supply voltage
- HCMOS/TTL Output
- Stability to $\pm 10\text{ppm}$
- Tri-state function available
- Suitable for reflow soldering

PART NUMBER GUIDE

COZ-01 - 10.0 - 20 - B - S

PACKAGE TYPE

- COZ-05 : SMD-3.2x2.5x1.2mm (5.0V)
- COZ-03 : SMD-3.2x2.5x1.2mm (3.3V)
- COZ-03A : SMD-3.2x2.5x1.2mm (3.0V)
- COZ-03M : SMD-3.2x2.5x1.2mm (1.8V to 3.3V)
- COZ-02 : SMD-3.2x2.5x1.2mm (2.5V)
- COZ-02A : SMD-3.2x2.5x1.2mm (2.8V)
- COZ-01 : SMD-3.2x2.5x1.2mm (1.8V)**

FREQUENCY

1.000MHz~156.000MHz

FREQUENCY STABILITY

20 : $\pm 20\text{ppm}$

PIN 1 CONNECTION

S : TRI-STATE, E/D
Blank : No Connection

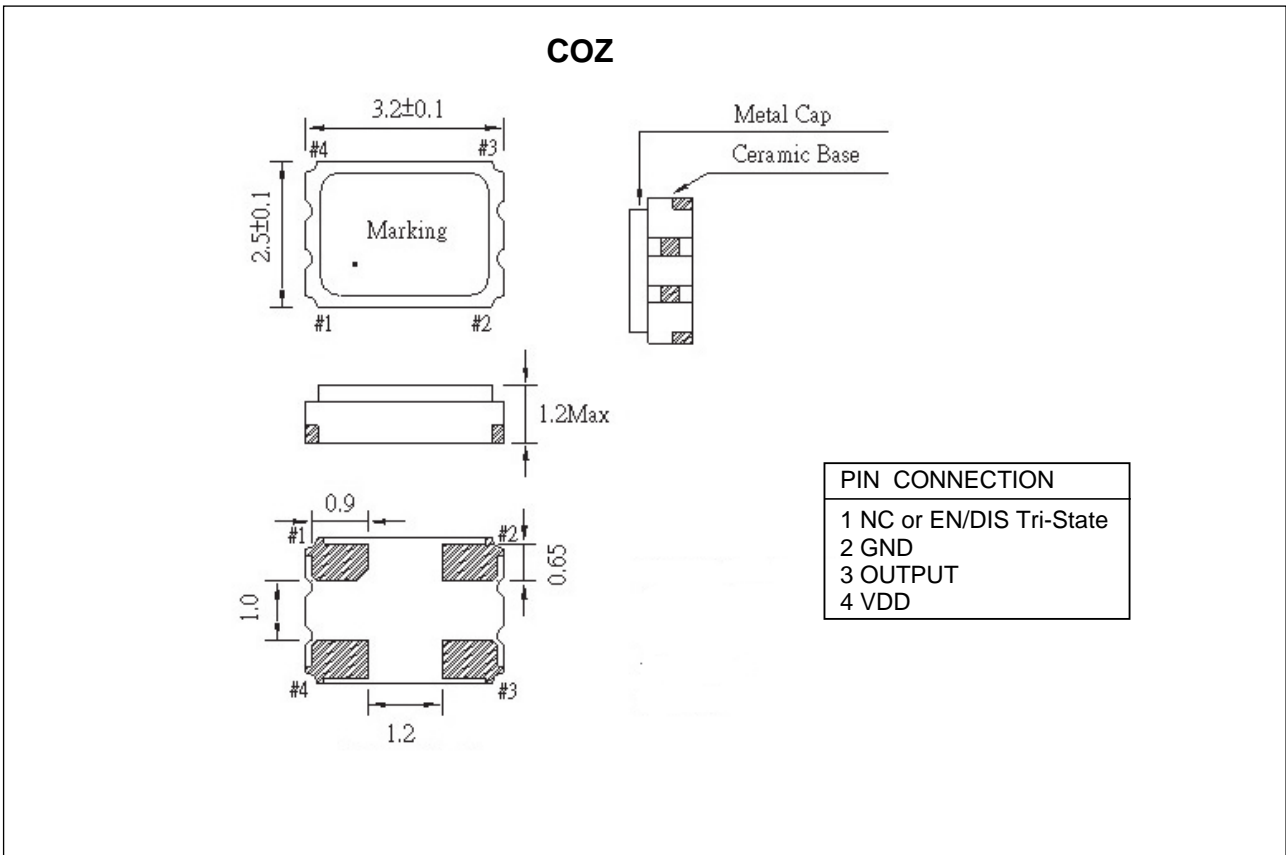
OPERATING TEMPERATURE

A : -40°C to $+85^{\circ}\text{C}$
B : -20°C to $+70^{\circ}\text{C}$
C : -10°C to $+70^{\circ}\text{C}$
D : 0°C to $+70^{\circ}\text{C}$

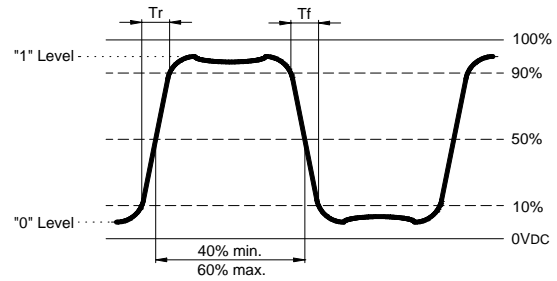
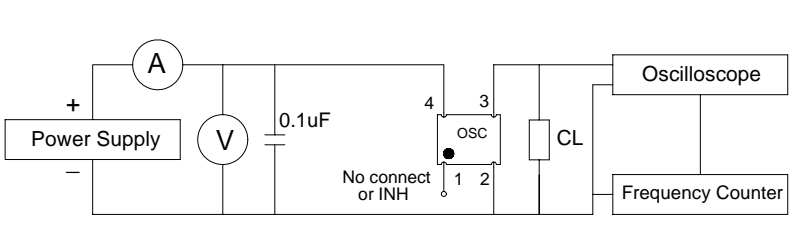
ELECTRICAL SPECIFICATIONS

MODEL	COZ-01
Frequency	10.000MHz
Vibration Mode	AT cut, Fundamental
Frequency Stability	$\pm 20\text{ppm}$
Operating Temperature Range	-20°C to $+70^{\circ}\text{C}$
Storage Temperature Range	-55°C to $+125^{\circ}\text{C}$
Supply Voltage (VDD)	1.8V $\pm 5\%$
Current consumption	7mA Max.
Load	15pf
Output Level	CMOS
Start up Time	5ms Max.
Rise / Fall Time	5ns Max.
Output Symmetry	45~55 % (at 50% VDD)
Phase jitter (integrated 10KHz ~ 20Mhz)	1ps RMS
Aging (at 25°C)	$\pm 3\text{ppm/ year}$ Max
Min. Packing	3000pcs/ Reel

MECHANICAL DIMENSION

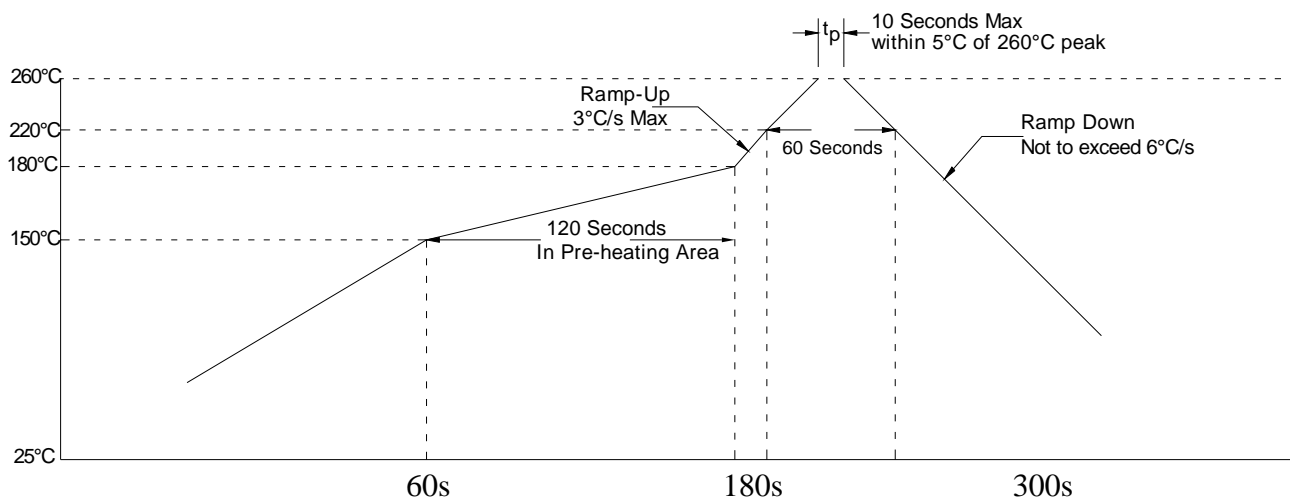


TEST CIRCUIT



SPECIFICATION OF CRYSTAL

Soldering reflow



Pb-free compliance

Component and Assembly Pb content shall be less than 0.1% by weight of the device (in accordance with IPC/EIA J-STD-006, European ROHS 3 Directive (EU) 2015/865).

Product Information

For a product to be **RoHS** compliant, it must satisfy several conditions:

- Contain no more than the specified limits of the target hazardous substances set out in the RoHS Directive
- Able to withstand Pb-free 260°C solder reflow profile below
- External packaging and terminations are Pb-free
- Internal PCB, components, solders, and terminations are Pb-free

EACH Regulation (EC) 1907/2006

Above concerned part is compliant with all requirement in the REACH regulations EC No. 1907/2006.

SPECIFICATION OF CRYSTAL

Reliability Test (applicable to OSC and SMD type X'tal)

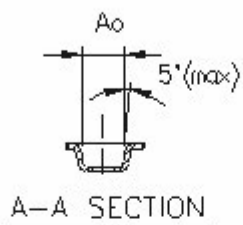
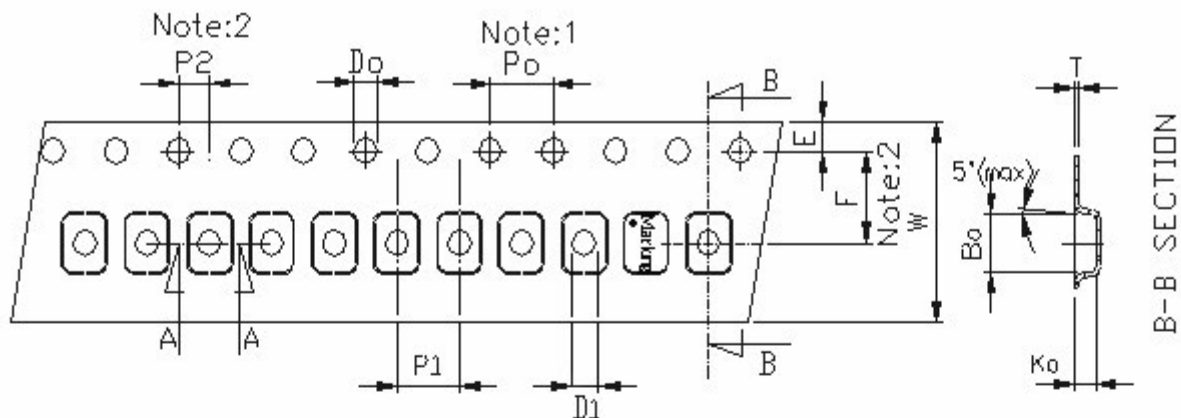
Test Items	Test Condition	Specification	
		General OSC (Note:1)	General X' tal (Note:2)
1. Gross Leak Test	FC-40 125°C/30sec	No continuous bubble	
2. Fine Leak Test	Bombing of He 5kg/cm ² for 2 hours	Less than 1*10 ⁻⁸ atm.c.c./sec, Helium	
3. Drop Test	Free dropped a. ~19.999MHz(Fund.) →100 cm height b. 20~29.999MHz(Fund.) →50 cm height c. 30~ MHz(Fund.) →20 cm height on a hard wooden board for 3 times (board is thickness more than 30 mm)	$\Delta F \leq \pm 10\text{PPM}$, Duty within spec.	$\Delta F \leq \pm 10\text{PPM}$, $\Delta C.I. \leq \pm 10\text{ohms}$
4. Vibration Test	Freq. range: 10~55Hz Peak to peak amplitude:1.5mm Peak acceleration:10 G 3 direction(X,Y,Z) , each 60min.	$\Delta F \leq \pm 10\text{PPM}$, Duty within spec.	$\Delta F \leq \pm 10\text{PPM}$, $\Delta C.I. \leq \pm 10\text{ohms}$
5. Resistance to Soldering Test	a. IR Reflow furnace with the condition 2 times. Peak temp. 260±3°C , 10sec(Min.)	$\Delta F \leq \pm 10\text{PPM}$, Duty within spec. For SMD OSC only	$\Delta F \leq \pm 10\text{PPM}$, $\Delta C.I. \leq \pm 10\text{ohms}$
	b. Dip terminals in a 260±5°C solder bath for 5±0.5 sec.	At least 90% of each dipped area shall be covered by fresh solder. For DIP OSC only.	NA
6. Bending Test	Bending cycle : 1 cycle 0° -> 45° -> 0° -> 45° -> 0°	$\Delta F \leq \pm 5\text{PPM}$, Duty within spec. For DIP OSC only.	NA
7. Share Test	Weight : 10N, Test duration : 10±1 sec	$\Delta F \leq \pm 5\text{PPM}$, Duty within spec. For SMD OSC only.	$\Delta F \leq \pm 10\text{PPM}$, $\Delta C.I. \leq \pm 10\text{ohms}$
8. Low Temp. Exposure Test	-40±3°C, 240±12 hrs	$\Delta F \leq \pm 10\text{PPM}$, Duty within spec.	$\Delta F \leq \pm 10\text{PPM}$, $\Delta C.I. \leq \pm 10\text{ohms}$
9. Aging Test	125±3°C, 240±12hrs	$\Delta F \leq \pm 10\text{PPM}$, Duty within spec.	$\Delta F \leq \pm 10\text{PPM}$, $\Delta C.I. \leq \pm 10\text{ohms}$
10. High Temp. & Humidity Test	+85°C±5°C & 85%±5% R.H. , 240±12 hrs	$\Delta F \leq \pm 10\text{PPM}$, Duty within spec.	$\Delta F \leq \pm 10\text{PPM}$, $\Delta C.I. \leq \pm 10\text{ohms}$
11. Temperature Cycling Test	-40±3°C/15±3min ~ +85±3°C/15±3min 15cycles	$\Delta F \leq \pm 10\text{PPM}$, Duty within spec.	$\Delta F \leq \pm 10\text{PPM}$, $\Delta C.I. \leq \pm 10\text{ohms}$

Note:1 → For communication application the spec. demanded " $\Delta F \leq \pm 5\text{ PPM}$, Duty within spec." .

Note:2 → For communication application the spec. demanded " $\Delta F \leq \pm 5\text{ PPM}$, $\Delta C.I. \leq \pm 5\text{ ohms}$ " .

SPECIFICATION OF TAPE & REEL

Taping



$$A_0 = \frac{2.70 \pm 0.10}{\text{mm}}$$

$$B_0 = \frac{3.40 \pm 0.10}{\text{mm}}$$

$$K_0 = \frac{1.40 \pm 0.10}{\text{mm}}$$

Unit: mm

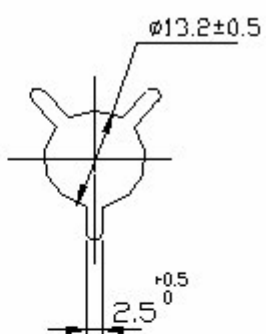
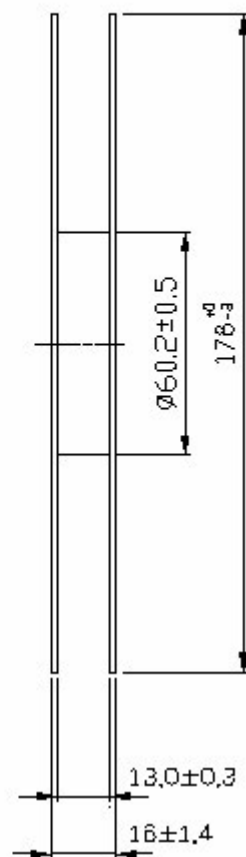
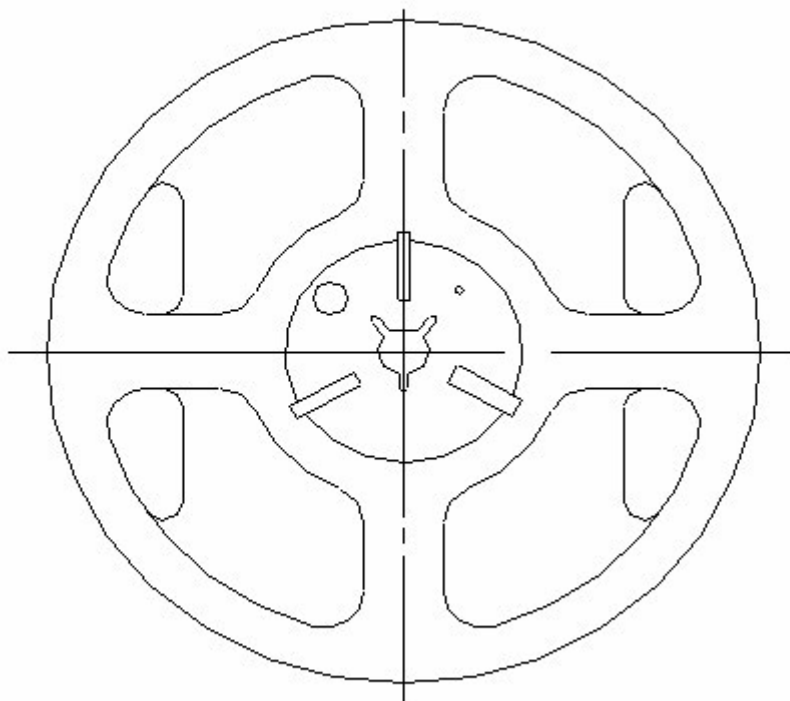
Symbol	Spec.
K1	-
Po	4.0±0.10
P1	4.0±0.10
P2	2.0±0.10
Do	1.55±0.05
D1	1.50(MIN)
E	1.75±0.10
F	5.50±0.10
10Po	40.0±0.10
W	12.0±0.20
T	0.25±0.05

Notice:

1. 10 Sprocket hole pitch cumulative tolerance is ±0.1mm
2. Pocket position relative to sprocket hole measured as true position of pocket not pocket hole.
3. Ao & Bo measured on a plane 0.3mm above the bottom of the pocket to top surface of the carrier.
4. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
5. Carrier camber shall be not than 1mm per 100mm through a length of 250mm.

SPECIFICATION OF TAPE & REEL

Reel



Unit:mm

Q'ty:3000pcs/reel